

Speech by SITI at HKSTP x Würth Elektronik Advanced Manufacturing in Hong Kong: Enabling Global Microelectronics Innovations (English only) (with photo)

Following is the speech by the Secretary for Innovation, Technology and Industry, Professor Sun Dong, at HKSTP x Würth Elektronik Advanced Manufacturing in Hong Kong: Enabling Global Microelectronics Innovations today (May 23):

Albert (Chief Executive Officer of the Hong Kong Science and Technology Parks Corporation, Mr Albert Wong), Thomas (Chief Executive Officer of Würth Elektronik eiSos Group, Mr Thomas Garz), distinguished guests, ladies and gentlemen,

Good afternoon. It is my pleasure to join you today to celebrate the launch of the Engineering Service Programme, a groundbreaking partnership between Hong Kong Science and Technology Parks (HKSTP) and Würth Electronics at the Advanced Manufacturing Centre (AMC). This collaboration marks a significant milestone for Hong Kong's innovation and technology (I&T) ecosystem, as Würth Electronics expands its footprint from R&D (research and development) to advanced manufacturing in our city.

As a global leader in electronic components, Würth Electronics is synonymous with innovation, precision, and reliability, the qualities that have made it the key partner of industry giants worldwide. By establishing new engineering, testing, and logistics centres at the AMC, Würth Electronics places its confidence in Hong Kong as an ideal hub for cutting-edge innovation and advanced manufacturing. This move also underscores Hong Kong's unique advantages: our world-class talent, robust R&D capabilities, and seamless connectivity to global markets.

And this is just the beginning. The Engineering Service Programme will equip our local ecosystem with specialised tools and expertise, accelerating progress in microelectronics and advanced manufacturing. From R&D to prototyping and small-scale production, this programme will support companies at every stage – perfectly aligning with the Government's strategy to foster high-value, tech-driven industries and cement Hong Kong's role in the global I&T landscape. With Würth Electronics' global network and HKSTP's local support, the programme is poised to become a testing ground for next-generation industrial solutions.

Hong Kong has long been a frontrunner in microelectronics, and we are building on this strength. Through initiatives like the New Industrialisation Acceleration Scheme and the establishment of the Hong Kong Microelectronics

Research and Development Institute, we are providing targeted support for these critical sectors. Beyond that, we are investing heavily in infrastructure, talent development, and strategic partnerships – all to build a thriving, future-ready I&T ecosystem.

This partnership is a prime example of how public-private collaboration can drive innovation forward. Once again, my congratulations to Würth Electronics and HKSTP for their bold leadership in shaping Hong Kong into a global microelectronics hub. Together, let us unite the Government, the industry, academia, research and investment sectors to unlock even greater opportunities for technological advancement and economic growth. Thank you.

